



Date: May 16, 1995

Reference: Standards Proposal No. 3389, Proposed New Standard "PCS 1900 Air Interface Specification" (if approved, to be published as J-STD-007)

Company Name: PHILIPS ELECTRONICS N.V.

Address: Groenewoudseweg 1

5600 MD EINDHOVEN THE NETHERLANDS

Contact Person Regarding Patents and Intellectual Property Matters:

R.J. Peters

(Name Printed)

Title: Director Philips International B.V.

Telephone and FAX: (T) 040 - 743422 (F) 040 - 743489

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NOTE: If not attached, indicate when the envelope will be received at TIA. Indicate the company name and proposed Standard number on the outside. Date due at TIA: _____

Agreed, on behalf of the above Company: _____

(Signature)

Name (printed): A. Westerlaken

Date: July 31, 1995

Date: May 16, 1995

Reference: Standards Proposal No. 3389, Proposed New Standard "PCS
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PHILIPS

Philips International B.V.

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Corporate Patents and Trademarks

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U.S.A.

Tel: +31 40 743422

Attn: Mr. Thanos Kipreos
Director, Technical and Regulatory Affairs

Ref: H407

PETE/MvS

Date: 31 July 1995

Re: Patent Statement re Standards Proposal No. 3389
"PCS 1900 Air Interface Specification"

Dear Mr. Kipreos,

Referring to your letter dated May 16, 1995 we herewith send you attached:

- (i) the standard TIA-patent statement regarding the above referenced standard-proposal confirming our earlier patent statement dated November 7, 1994, and
- (ii) a sealed envelope containing our licensing terms and conditions for a license under our essential patents re this standard proposal, for transmittal by TIA to ANSI.

Yours sincerely,

PHILIPS INTERNATIONAL B.V.
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R.J. Peters

Encl.: - patent statement
- sealed envelope

Cc.: Mr. Young - TIA